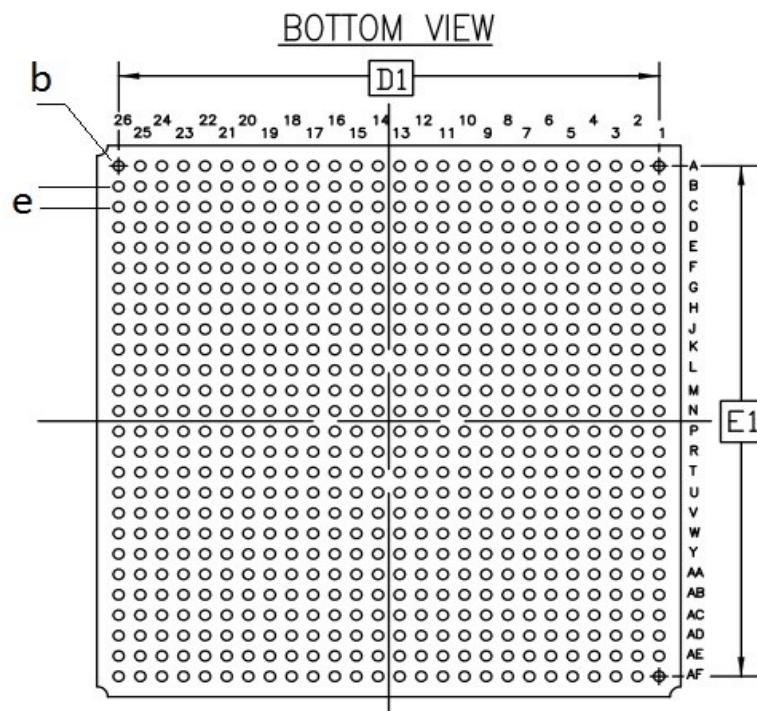


FG-676, BGA676 1.0mm - stencil

Units		MILLIMETERS		
Dimension Limit		MIN	NOM	MAX
Contact Pitch	e	1.00		
Contact Pad Spacing	E1		25.00	
Contact Pad Spacing	D1		25.00	
Contact Pad diameter	b		0.50	

SMD Footprint



Stencil dimensions: 49mm x 44mm

Thickness: 100-127µm

Material: stainless steel or nickel silver

Manufacturing processes: lasering or chemical etching

Datasheet rev.: 1.04